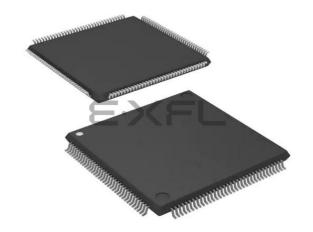
# Lattice Semiconductor Corporation - <u>LFEC6E-5T144C Datasheet</u>



Welcome to **E-XFL.COM** 

# Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	6100
Total RAM Bits	94208
Number of I/O	97
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°С ~ 85°С (ТJ)
Package / Case	144-LQFP
Supplier Device Package	144-TQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec6e-5t144c

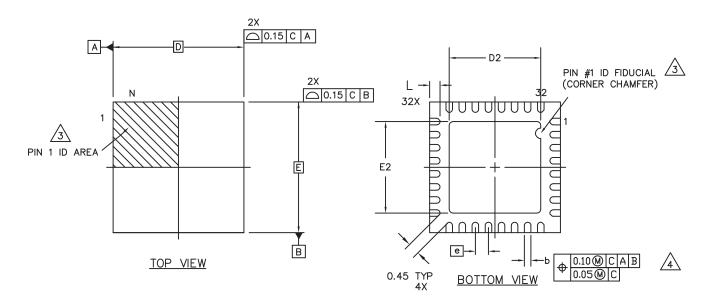
Email: info@E-XFL.COM

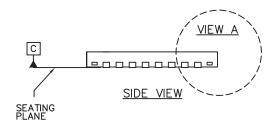
Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

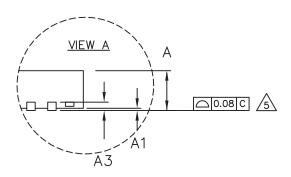


## 32-Pin QFN Package Option 3: MachXO2 SG32C

**Dimensions in Millimeters** 







NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.

EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM TERMINAL TIP.

 $\stackrel{\textstyle \frown}{}$  Applies to exposed portion of terminals.

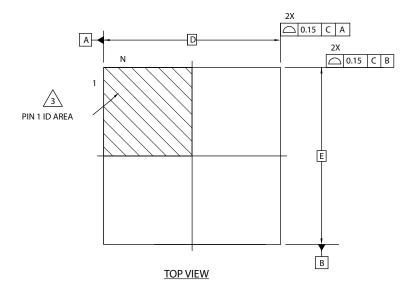
6. JEDEC REFERENCE MO-248 AND DR-4.2

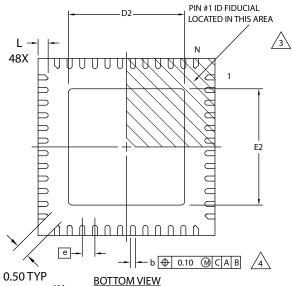
SYMBOL	MIN.	NOM.	MAX.	
А	0.50	0.55	0.65	
A1	0.00	0.02	0.05	
А3		0.2 REF		
D	5.0 BSC			
D2	3.40	3.50	3.60	
E	5.0 BSC			
E2	3.40	3.50	3.60	
b	0.18	0.25	0.30	
е	0.50 BSC			
L	0.35	0.40	0.45	

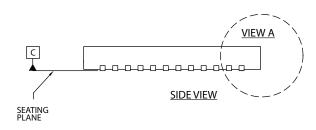


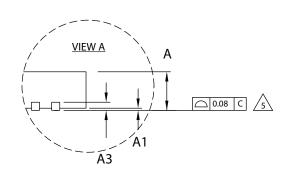
# 48-Pin QFN Package Option 1

### **Dimensions in Millimeters**









NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.

 $\underline{ \begin{tabular}{ll} $\lambda$ & EXACT SHAPE AND SIZE OF THIS \\ FEATURE IS OPTIONAL. \end{tabular}$ 

DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM TERMINAL TIP.

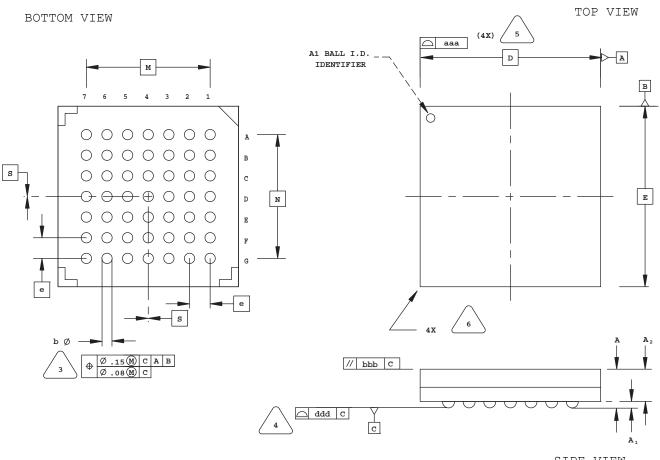
APPLIES TO EXPOSED PORTION OF TERMINALS.

SYMBOL	MIN.	NOM.	MAX.		
А	0.80	0.90	1.00		
A1	0.00	0.02	0.05		
А3	0.2 REF				
D	7.0 BSC				
D2	3.00	-	5.80		
E	7.0 BSC				
E2	3.00	-	5.80		
b	0.18	0.24	0.30		
е	0.50 BSC				
L	0.30	0.40	0.50		



## 49-Ball caBGA Package

### **Dimensions in Millimeters**



SIDE VIEW

NOTES: UNLESS OTHERWISE SPECIFIED

- DIMENSIONS AND TOLERANCES 1. PER ANSI Y14.5M.
- ALL DIMENSIONS ARE IN MILLIMETERS. 2.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

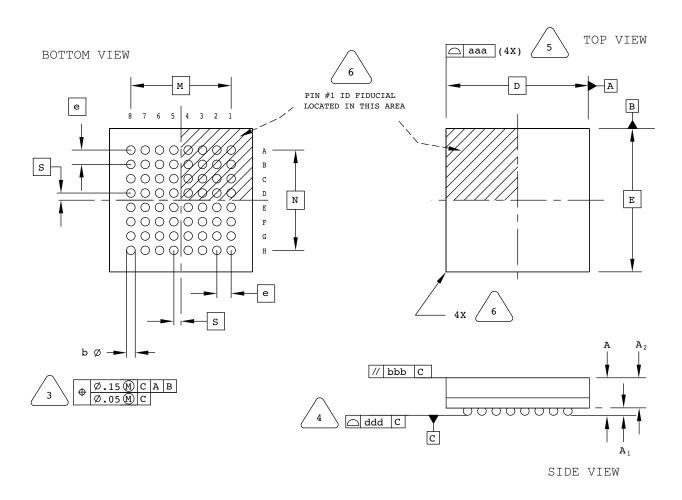


SYMBOL	MIN.	NOM.	MAX.		
A	1.30	1.40	1.50		
A1	0.31	0.36	0.41		
A2	0.99	1.04	1.09		
D/E	7.00 BSC				
M/N	4.80 BSC				
s		0 BSC			
b	0.40	0.52			
е	0	.80 BSC			
aaa	-				
bbb	-	-	0.10		
ddd	-	-	0.12		



## 64-Ball csBGA Package

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

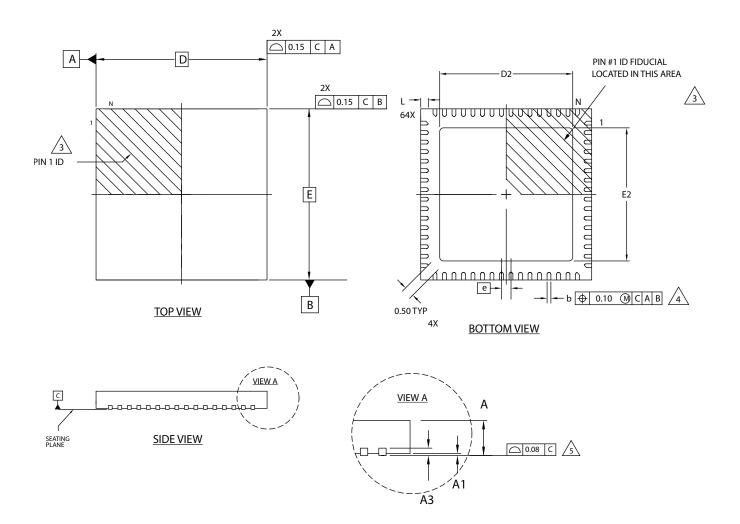


SYMBOL	MIN.	NOM.	MAX.		
A	0.90	1.00	1.10		
A1	0.15	_	-		
A2	-	-	0.85		
D/E	5.00 BSC				
M/N	3.50 BSC				
S	0.25 BSC				
b	0.25	0.30	0.35		
е	0	.50 BSC			
aaa	_	_	0.10		
bbb	_	_	0.10		
ddd	_	_	0.08		



# 64-Pin QFNS Package

### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.

EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

DIMENSION b APPLIES TO PLATED
TERMINAL AND IS MEASURED BETWEEN
0.15 AND 0.30 mm FROM TERMINAL TIP.

\_APPLIES TO EXPOSED PORTION OF TERMINALS.

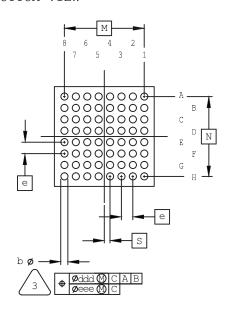
SYMBOL	MIN.	NOM.	MAX.	
A	0.80	0.90	1.00	
A1	0.00	0.02	0.05	
А3		0.2 REF		
D	9.0 BSC			
D2	5.00	_	7.50	
E	9.0 BSC			
E2	5.00	-	7.50	
b	0.18	0.24	0.30	
е	0.50 BSC			
L	0.30	0.40	0.50	

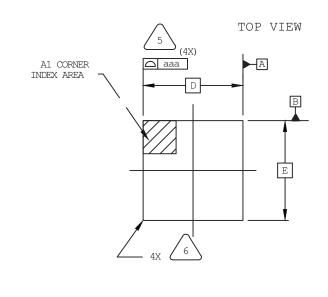


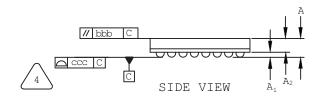
## 64-Ball ucfBGA Package

#### **Dimensions in Millimeters**

#### BOTTOM VIEW







NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM [C].



PRIMARY DATUM [C] AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.



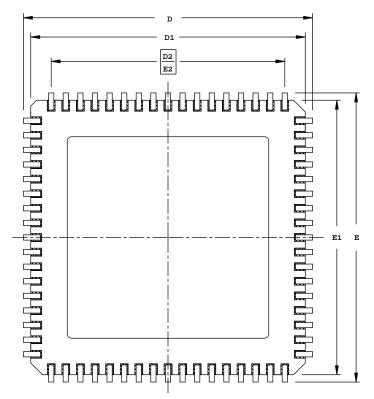
SYMBOL	MIN.	NOM.	MAX.	
А	-	_	1.00	
A1	0.11	-	-	
A2	0.62	-	_	
D/E		3.50 BSC		
M/N	2.80 BSC			
S	0.20 BSC			
b	0.20 0.25 0.30			
е	0.40 BSC			
aaa	0.10			
bbb	0.10			
ccc	0.08			
ddd	0.15			
eee		0.08		

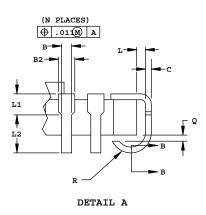


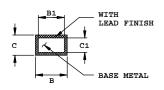
# 68-Pin JLCC Package

### Dimensions in Inches

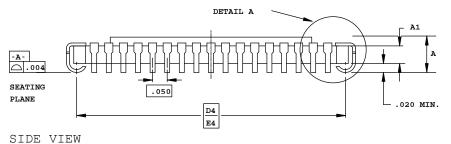
#### BOTTOM VIEW







SECTION B-B



#### NOTES:

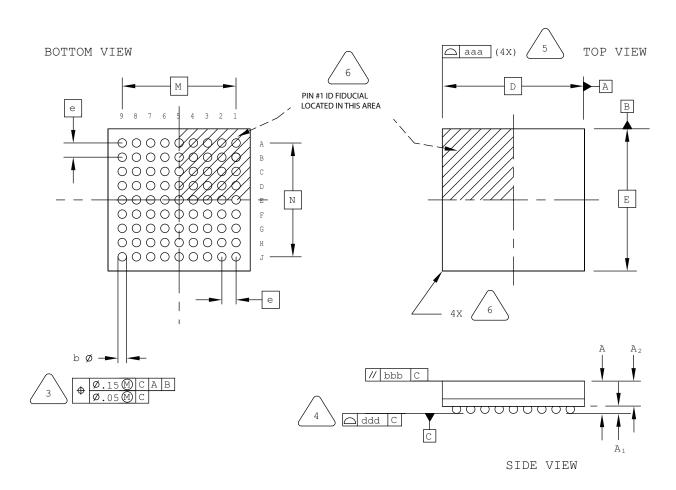
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN INCHES.
- 3. CORNER CHAMFERS AND/OR NOTCHES ARE OPTIONAL.

S M B O L	INCHES MAX.					
o r						
A	.115	ı	.190			
A1	. (	80 RE	F			
В	.013	-	.023			
B1	.013	-	.020			
B2	.022	.035				
С	.007	.013				
C1	.007	-	.010			
D/E	.975	.990	1.000			
D1/E1	.920	1	.960			
D2/E2	. 8	00 BS	С			
D4/E4	. 9	30 BS	C			
L	.005	-	-			
L1	.020	-	-			
L2	.025	-	-			
Q	.003	•	1			
R	.02004					
N	68					



## 81-Ball ucBGA Package

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

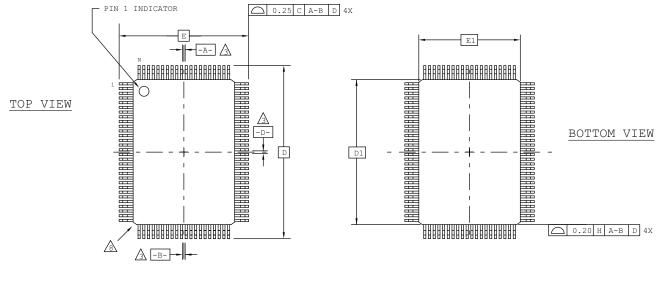


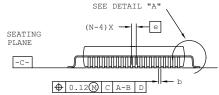
SYMBOL	MIN.	NOM.	MAX.	
А	-	-	1.00	
A1	0.10	_	-	
A2	1	-	0.90	
D/E	4.00 BSC			
M/N	3.20 BSC			
b	0.20	0.25	0.30	
е	0	.40 BSC		
aaa	_	_	0.10	
bbb	-	_	0.10	
ddd	-	_	0.10	

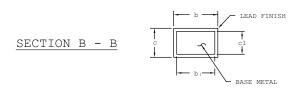


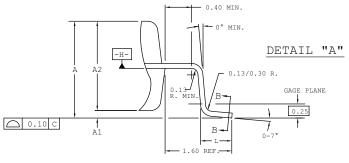
## 100-Pin PQFP Package

#### **Dimensions in Millimeters**









#### NOTES:

- 1.0 DIMENSIONING AND TOLERANCING PER ANSI Y14.5 1982.
- 2.0 ALL DIMENSIONS ARE IN MILLIMETERS.
- DATUMS A, B AND D TO BE DETERMINED AT DATUM PLANE H.
- 4.0 DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION.
  ALLOWABLE MOLD PROTRUSION IS 0.254 MM ON D1 AND E1
  DIMENSIONS.
- 5.0 THE TOP OF PACKAGE MAY BE SMALLER THAN THE BOTTOM OF THE PACKAGE BY 0.15 MM.
- 7.0 A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.

8	EXACT	SHAPE	OF	EACH	CORNER	IS	OPTIONAL.

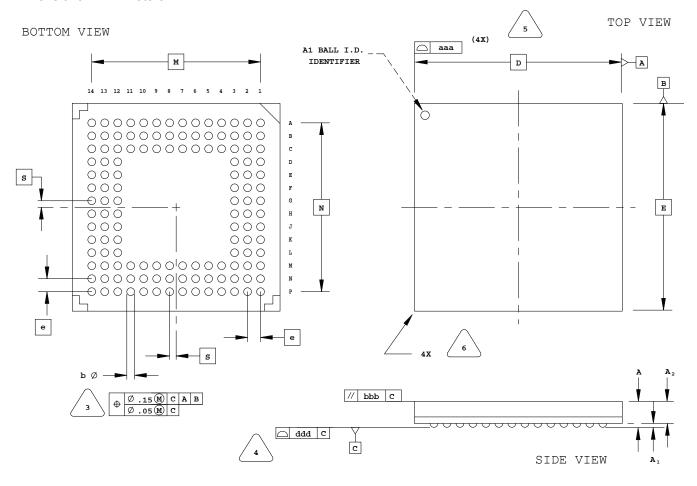
♠ EXACT SHAPE OF EXPOSED HEATSINK IS OPTIONAL.

SYMBOL	MIN.	NOM.	MAX.	
A	-	-	3.40	
A1	0.25	1	0.50	
A2	2.50	2.70	2.90	
D		23.20 BSC	!	
D1		20.00 BSC	!	
E	17.20 BSC			
E1		14.00 BSC	!	
L	0.73	1.03		
N	100			
е	0.65 BSC			
b	0.22 - 0.4			
b1	0.22	0.30	0.36	
U	0.11	-	0.23	
c1	0.11	0.15	0.19	



# 132-Ball csBGA Package Option 1: MachXO2, MachXO, LatticeXP2™

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

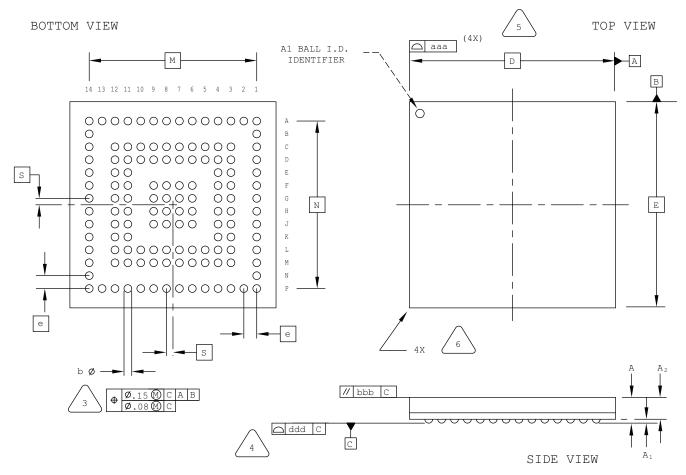


	Г				
SYMBOL	MIN.	NOM.	MAX.		
A	0.90	1.23	1.35		
A1	0.15	-	-		
A2	-	-	1.10		
D/E	8	.00 BSC			
M/N	6.50 BSC				
s	0.	.25 BSC			
b	0.25	0.30	0.35		
е	0	.50 BSC			
aaa	-	-	0.10		
bbb	-	-	0.10		
ddd	-	-	0.08		



## 132-Ball csBGA Package Option 2: iCE40

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM [C]



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

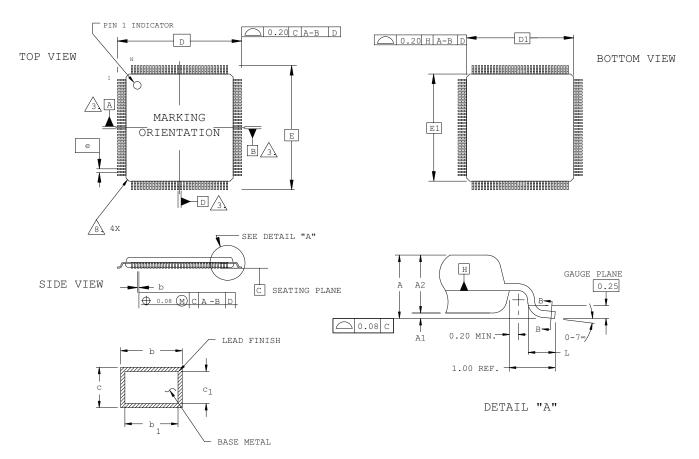


SYMBOL	MIN.	NOM.	MAX.
А	ı	-	1.00
A1	0.15	_	-
A2	ı	_	0.85
D/E	8.00 BSC		
M/N	6.50 BSC		
S	0.25 BSC		
b	0.25	0.30	0.35
е	0.50 BSC		
aaa	-	-	0.10
bbb	-	-	0.10
ddd	_	_	0.08



# 144-Pin TQFP Package

### **Dimensions in Millimeters**



SECTION B - B

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5 1982.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.

 $\sqrt{}_3$  DATUMS A, B AND D TO BE DETERMINED AT DATUM PLANE H.

- DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTRUSION IS 0.254 MM ON D1 AND E1 DIMENSIONS.
- THE TOP OF PACKAGE MAY BE SMALLER THAN THE BOTTOM OF THE PACKAGE BY 0.15 MM.
- 6. SECTION B-B:  $\begin{tabular}{lllll} THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 AND 0.25 MM FROM THE LEAD TIP. \\ \end{tabular}$
- 7. Al is defined as the distance from the seating plane to the lowest point on the package body.

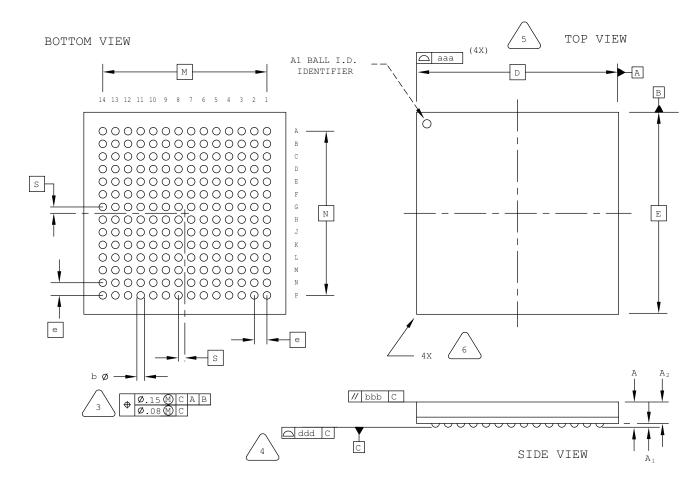
 $\sqrt{8}$  EXACT SHAPE OF EACH CORNER IS OPTIONAL.

SYMBOL	MIN.	NOM.	MAX.
A	-	-	1.60
A1	0.05	-	0.15
A2	1.35	1.40	1.45
D		22.00 BSC	
D1	20.00 BSC		
Е	22.00 BSC		
E1	20.00 BSC		
L	0.45	0.60	0.75
N	144		
е	0.50 BSC		
b	0.17	0.22	0.27
b1	0.17	0.20	0.23
С	0.09	0.15	0.20
c1	0.09	0.13	0.16



### 196-Ball csBGA Package

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

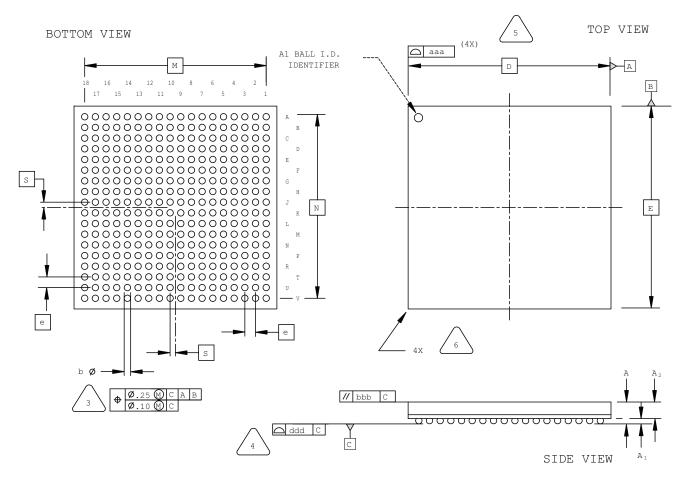


SYMBOL	MIN.	NOM.	MAX.
А	-	-	1.00
A1	0.15	_	_
A2	_	_	0.85
D/E	8.00 BSC		
M/N	6.50 BSC		
S	0.25 BSC		
b	0.25	0.30	0.35
е	0.50 BSC		
aaa	_	_	0.10
bbb	_	_	0.10
ddd	_	_	0.08



# 324-Ball ftBGA Package

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

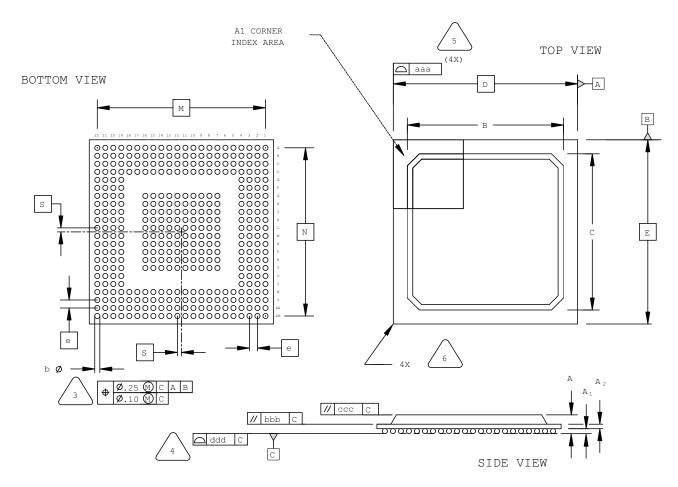


SYMBOL	MIN.	NOM.	MAX.
A	1.25	1.50	1.70
A1	0.30	-	1
A2	-	-	1.40
D/E	19.0 BSC		
M/N	17.0 BSC		
S	0.50 BSC		
b	0.40	0.60	0.70
е	1.00 BSC		
aaa			0.20
bbb	_	_	0.25
ddd	-	-	0.20



## 388-Ball fpBGA Package

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

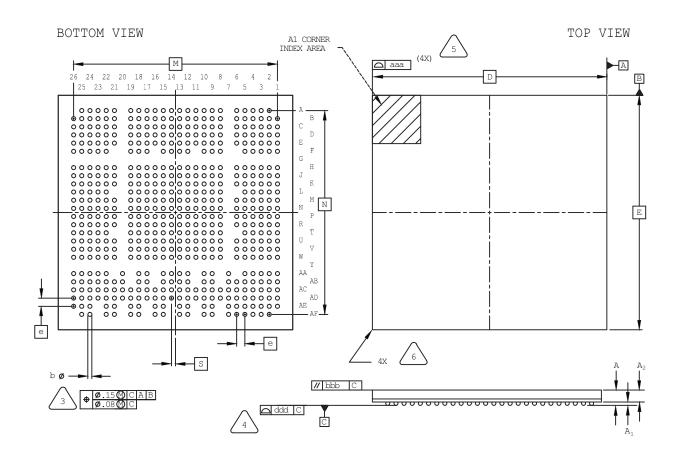


SYMBOL	MIN.	NOM.	MAX.
А	1.70	2.15	2.60
A1	0.30	0.50	0.70
A2	0.30	0.50	0.70
B/C	19.30	19.80	20.30
D/E	23.00 BSC		
M/N	21.00 BSC		
S	0.50 BSC		
b	0.50	0.60	0.70
е	1.00 BSC		
aaa			0.20
bbb			0.25
ccc	-	-	0.35
ddd	-	-	0.20



### 554-Ball caBGA Package

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.

2. ALL DIMENSIONS ARE IN MILLIMETERS.

 $\sqrt{3}$ 

DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM  $\boxed{\mathbb{C}}$ 



PRIMARY DATUM [C] AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

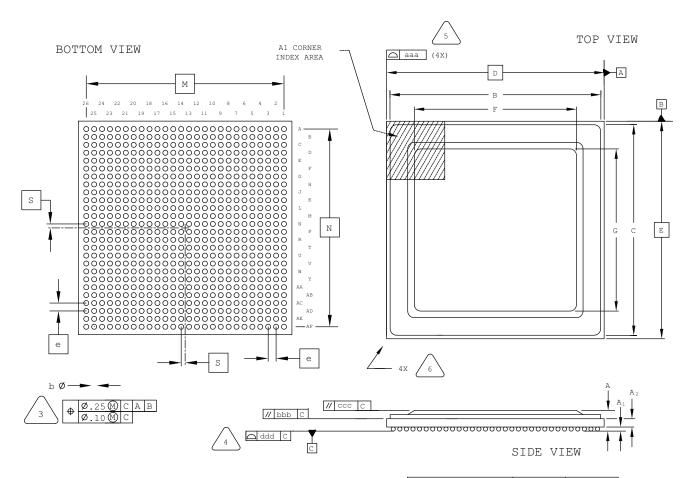


SYMBOL	MIN.	NOM.	MAX.
А	-	-	1.76
A1	0.25	0.30	0.35
A2	0.80	-	-
D/E	23.0 BSC		
M/N	20.0 BSC		
S	0.40 BSC		
b	0.35	0.40	0.45
е	0.80 BSC		
aaa	_	_	0.15
bbb	-	_	0.20
ddd	_	_	0.12



## 676-Ball fcBGA Package

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.

2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

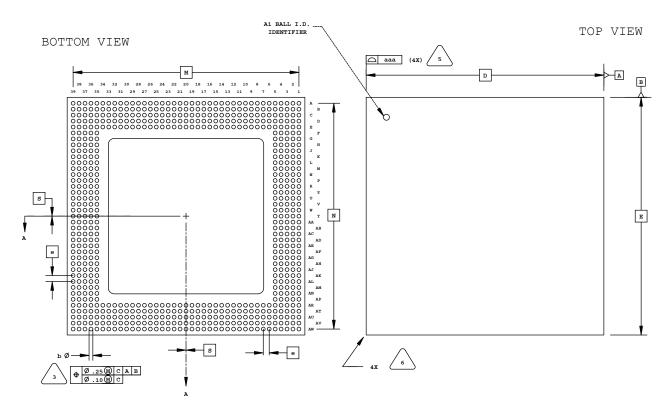


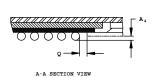
SYMBOL	MIN.	NOM.	MAX.
A	2.55	2.90	3.25
A1	0.40	0.50	0.60
A2	1	1.20 REF	
B/C	26.55	26.60	26.65
D/E	2	7.00 BSC	
F/G	18.55	18.60	18.65
M/N	25.00 BSC		
S	0.50 BSC		
b	0.50	0.60	0.70
е	1.00 BSC		
aaa	-	-	0.20
bbb	-	-	0.25
ccc	-	-	0.35
ddd	_	_	0.20

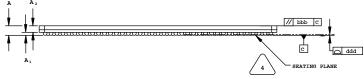


## 680-Ball fpSBGA Package

#### **Dimensions in Millimeters**







SIDE VIEW

NOTES: UNLESS OTHERWISE SPECIFIED

- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING
PLANE ARE DEFINED BY THE SPHERICAL
CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

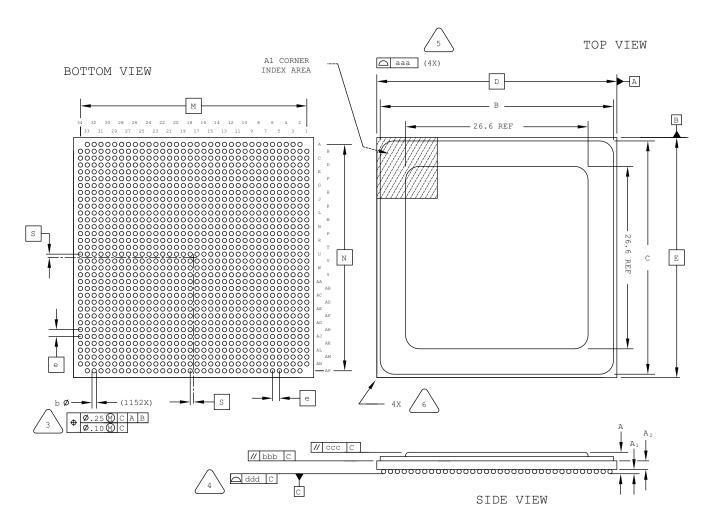


SYMBOL	MIN.	NOM.	MAX.
A	-	-	1.70
A1	0.45	0.53	0.60
A2	0.90	0.98	1.05
D/E	40	0.00 BSC	
M/N	38.00 BSC		
s	0.00 BSC		
b	0.50	0.65	0.80
е	1.00 BSC		
Q	0.25	-	-
A4	0.10	-	-
aaa	-	-	0.20
bbb	-	-	0.25
ddd	-	-	0.20



## 1152-Ball Organic fcBGA Package Option 1: LatticeSC/SCM40

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

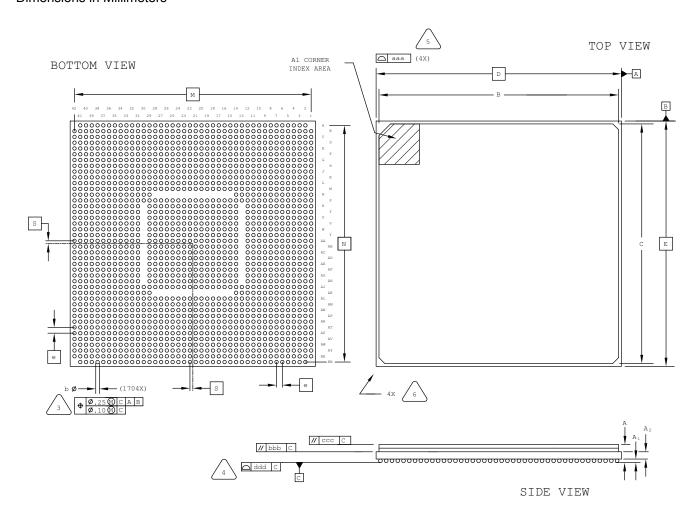


SYMBOL	MIN.	NOM.	MAX.
A	2.55	2.90	3.25
A1	0.35	0.50	0.65
A2	1	.20 REF	
B/C	34.25	34.50	34.75
D/E	35.00 BSC		
M/N	33.00 BSC		
S	0.50 BSC		
b	0.50	0.60	0.70
е	1.00 BSC		
aaa	-	-	0.20
bbb	-	-	0.25
ccc	-	-	0.35
ddd	_	_	0.20



## 1704-Ball Organic fcBGA Package

### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.



IN.		
-	NOM.	MAX.
55	2.90	3.25
.35	0.50	0.65
1	.20 REF	
.70	42.00	42.30
42.50 BSC		
42.50 BSC		
0.50 BSC		
.50	0.60	0.70
1.00 BSC		
-	-	0.20
-	_	0.25
-	-	0.35
-	-	0.23
	.70	.35 0.50 1.20 REF .70 42.00 42.50 BSC 42.50 BSC 0.50 BSC